

ICVIP2020

The 4th International Conference on Video and Image Processing

December 25-27, 2020 | Xi'an, China



Welcome to ICVIP2020! The 4th International Conference on Video and Image Processing will take place on December 25-27, 2020 in Xi'an, China which will be co-sponsored by Singapore Institute of Electronics and Xidian University, and technically assisted by many universities and organization worldwide.

CALL FOR PAPERS

Topics

- 3D images and models
- 3D imaging
- Advanced descriptors and similarity metrics for images, audio and video
- Affect-based indexing, search, and retrieval of images & videos
- Haptic devices and techniques
- High performance image/video indexing algorithms
- Human-computer interfaces
- Illumination and reflection techniques
- Image compression, coding, and encryption
- Image data structures for computer graphics
- Image feature extraction
- Image generation, acquisition, and processing
- Virtual reality techniques for behavioral and cognitive assessment
- Signal and speech processing
- Graphics algorithms and applications
- Virtual reality, visualization, and education
- Visual computing and graphics

Committees

Advisory Chair

David Zhang, Fellow of IEEE and IAPR, Chinese University of Hong Kong, Shenzhen, China,

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Proceedings

Accepted papers will be included in ICVIP2020 conference proceedings to be published with **ACM proceedings (ISBN: 978-1-4503-8907-5)**, which will be sent for indexing in **Ei Compendex, Scopus, IET and CPCI (Web of Science)** etc.

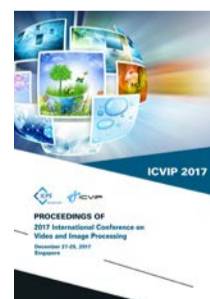
History



ICVIP 2019
Proceedings (ISBN: 978-1-4503-7682-2) are included in ACM Digital Library and indexed by Ei Compendex and Scopus already.



ICVIP 2018
Proceedings (ISBN: 978-1-4503-6613-7) are included in ACM Digital Library and indexed by Ei Compendex and Scopus already.



ICVIP 2017
Proceedings (ISBN: 9978-1-4503-5383-0) are included in ACM Digital Library and indexed by Ei Compendex and Scopus already.

Submission Deadline	November 10, 2020
Notification Date	November 25, 2020
Registration Deadline	December 10, 2020
Submission Link	http://confsys.iconf.org/submission/icvip2020

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